

# Features

1. The protection IC and The Dual-Nch MOSFET to use common Drain are integrated into One-packaging IC.
2. Reduced Pin-Count by fully connecting internally.
3. Application Part

## 1) Protection IC

- ① Uses high withstand voltage CMOS process.
  - The charger section can be connected up to absolute maximum rating 30V.
- ② Detection voltage precision
  - Overcharge detection voltage  $\pm 35\text{mV}$  ( $T_a=25^\circ\text{C}$ ),  $\pm 50\text{mV}$  ( $T_a=-30\sim 76^\circ\text{C}$ )
  - Overdischarge detection voltage  $\pm 60\text{mV}$  ( $T_a=25^\circ\text{C}$ ),  $\pm 70\text{mV}$  ( $T_a=-30\sim 76^\circ\text{C}$ )
  - Discharge overcurrent detection voltage  $\pm 10\text{mV}$  ( $T_a=25^\circ\text{C}$ ),  $\pm 20\text{mV}$  ( $T_a=-30\sim 76^\circ\text{C}$ )
  - Charging overcurrent detection voltage  $\pm 20\text{mV}$  ( $T_a=25^\circ\text{C}$ ),  $\pm 40\text{mV}$  ( $T_a=-30\sim 76^\circ\text{C}$ )

## ③ Built-in detection delay times (timer circuit)

- Overcharge detection delay time  $5.00\pm 1.50\text{s}$  ( $T_a=25^\circ\text{C}$ ),  $5.00[+3.1, -1.85]\text{s}$  ( $T_a=-30\sim 76^\circ\text{C}$ )
- Overdischarge detection delay time  $20.0\pm 6.0\text{ms}$  ( $T_a=25^\circ\text{C}$ ),  $20.0[+12.4, -7.2]\text{ms}$  ( $T_a=-30\sim 76^\circ\text{C}$ )
- Discharge overcurrent detection delay time  $12.0\pm 4.0\text{ms}$  ( $T_a=25^\circ\text{C}$ ),  $12.0[+7.4, -4.6]\text{ms}$  ( $T_a=-30\sim 76^\circ\text{C}$ )
- Charging overcurrent detection delay time  $16.0\pm 5.0\text{ms}$  ( $T_a=25^\circ\text{C}$ ),  $16.0[+10.0, -6.1]\text{ms}$  ( $T_a=-30\sim 76^\circ\text{C}$ )
- Short detection delay time  $400[+160, -170]\mu\text{s}$  ( $T_a=25^\circ\text{C}$ ),  $400[+400, -200]\mu\text{s}$  ( $T_a=-30\sim 76^\circ\text{C}$ )

## ④ 0V charge function is allowed

## ⑤ Auto Wake-up function is allowed

## 2) FET

- ① Using advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltage as low as 2.5V while retaining a 12V  $V_{GS(MAX)}$ .
- ② The protection for ESD
- ③ Common drain configuration
- ④ General characteristics
  - $V_{DS}$  (V) = 24V
  - $I_b$  (A) = 6A
  - $R_{SS(ON)} < 47\text{m}\Omega$  ( $V_{GS} = 3.9\text{V}$ ,  $I_b = 1\text{A}$ )
  - ESD Rating : 2000V HBM

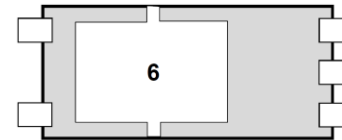
# Pin Assignment

[ Package: TEP-5L ]

<TOP VIEW>



<BOTTOM VIEW>



1	V <sub>DD</sub>
2	Source 1 (same as V <sub>SS</sub> )
3	Source 2
4	N.C (No connected)
5	V <sub>-</sub>
6	Drain

# Block Diagram

